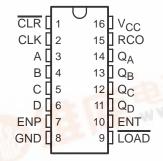
捷多邦,专业PCB打样 SN54LV 163A SN74LV163A 4-BIT SYNCHRONOUS BINARY COUNTERS

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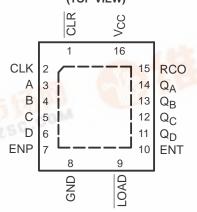
- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 9.5 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2.3 V at V_{CC} = 3.3 V, T_A = 25°C
- Support Mixed-Mode Voltage Operation on All Ports
- Internal Look Ahead for Fast Counting
- Carry Output for n-Bit Cascading

- Synchronous Counting
- Synchronously Programmable
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

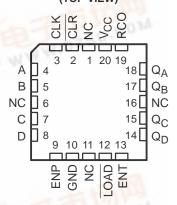
SN54LV163A...JOR W PACKAGE SN74LV163A...D, DB, DGV, NS, OR PW PACKAGE (TOP VIEW)



SN74LV163A . . . RGY PACKAGE (TOP VIEW)



SN54LV163A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

description/ordering information

ORDERING INFORMATION

TA	PACKA	GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
VW SIL	QFN – RGY	Reel of 1000	SN74LV163ARGYR	LV163A
11-1	2010 P	Tube of 40	SN74LV163AD	11/4004
	SOIC - D	Reel of 2500	SN74LV163ADR	LV163A
	SOP - NS	Reel of 2000	SN74LV163ANSR	74LV163A
-40°C to 85°C	SSOP – DB	Reel of 2000	SN74LV163ADBR	LV163A
		Tube of 90	SN74LV163APW	MAM M. D.
	TSSOP – PW	Reel of 2000	SN74LV163APWR	LV163A
	, T. F.	Reel of 250	SN74LV163APWT]
100	TVSOP - DGV	Reel of 2000	SN74LV163ADGVR	LV163A
- FB	CDIP – J	Tube of 25	SNJ54LV163AJ	SNJ54LV163AJ
-55°C to 125°C	CFP – W	Tube of 150	SNJ54LV163AW	SNJ54LV163AW
	LCCC – FK	Tube of 55	SNJ54LV163AFK	SNJ54LV163AFK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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description/ordering information (continued)

The 'LV163A devices are 4-bit synchronous binary counters designed for 2-V to 5.5-V V_{CC} operation.

These synchronous, presettable counters feature an internal carry look ahead for application in high-speed counting designs. The 'LV163A devices are 4-bit binary counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when instructed by the count-enable (ENP, ENT) inputs and internal gating. This mode of operation eliminates the output counting spikes normally associated with synchronous (ripple-clock) counters. A buffered clock (CLK) input triggers the four flip-flops on the rising (positive-going) edge of the clock waveform.

These counters are fully programmable; that is, they can be preset to any number between 0 and 9 or 15. As presetting is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with the setup data after the next clock pulse, regardless of the levels of the enable inputs.

The clear function for the 'LV163A devices is synchronous. A low level at the clear ($\overline{\text{CLR}}$) input sets all four of the flip-flop outputs low after the next low-to-high transition of CLK, regardless of the levels of the enable inputs. This synchronous clear allows the count length to be modified easily by decoding the Q outputs for the maximum count desired. The active-low output of the gate used for decoding is connected to $\overline{\text{CLR}}$ to synchronously clear the counter to 0000 (LLLL).

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. ENP, ENT, and a ripple-carry output (RCO) are instrumental in accomplishing this function. Both ENP and ENT must be high to count, and ENT is fed forward to enable RCO. Enabling RCO produces a high-level pulse while the count is maximum (9 or 15 with Q_A high). This high-level overflow ripple-carry pulse can be used to enable successive cascaded stages. Transitions at ENP or ENT are allowed, regardless of the level of CLK.

These counters feature a fully independent clock circuit. Changes at control inputs (ENP, ENT, or $\overline{\text{LOAD}}$) that modify the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) is dictated solely by the conditions meeting the stable setup and hold times.

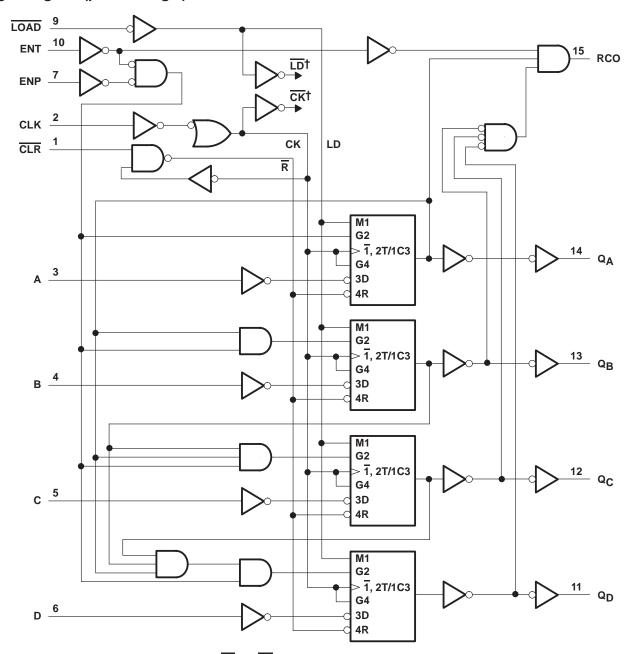
These devices are fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

FUNCTION TABLE

	11	NPUTS				OUTI	PUTS		
CLR	LOAD	ENP	ENT	CLK	QA	QB	QC	QD	FUNCTION
L	Х	Χ	Χ	Χ	L	L	L	L	Reset to "0"
Н	L	X	Χ		Α	В	С	D	Preset data
Н	Н	X	L			No ch	nange		No count
Н	Н	L	Χ		No change				No count
Н	Н	Н	Н		Count up				Count
Н	X	Χ	Χ		No change				No count



logic diagram (positive logic)



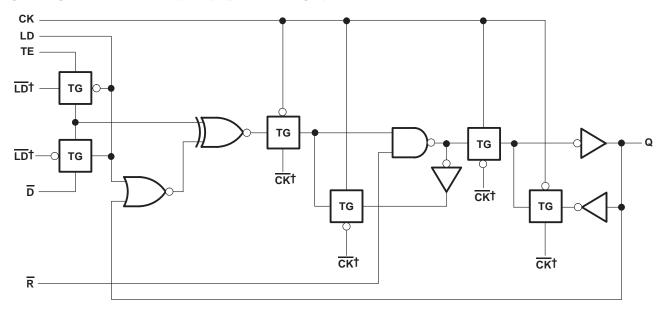
 $^{^{\}dagger}$ For simplicity, routing of complementary signals $\overline{\text{LD}}$ and $\overline{\text{CK}}$ is not shown on this overall logic diagram. The uses of these signals are shown on the logic diagram of the D/T flip-flops.

Pin numbers shown are for the D, DB, DGV, J, NS, PW, RGY, and W packages.



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logic diagram, each D/T flip-flop (positive logic)



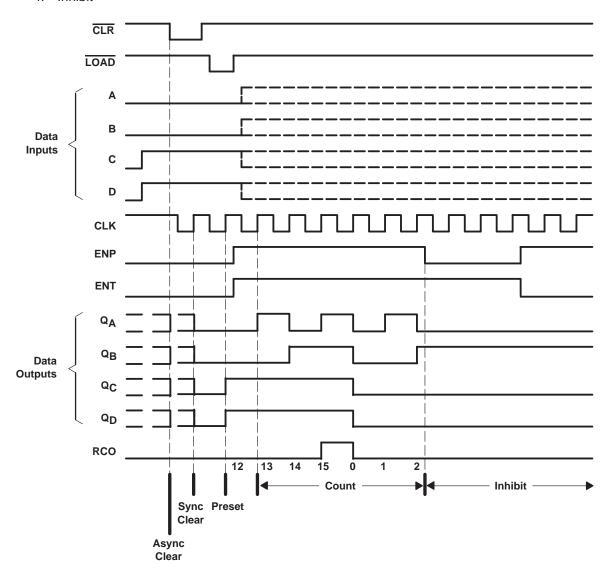
 \dagger The origins of $\overline{\text{LD}}$ and $\overline{\text{CK}}$ are shown in the overall logic diagram of the device.



typical clear, preset, count, and inhibit sequence

The following sequence is illustrated below:

- 1. Clear outputs to zero (synchronous)
- 2. Preset to binary 12
- 3. Count to 13, 14, 15, 0, 1, and 2
- 4. Inhibit



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	
Output voltage range applied in high or low state, V _O (see Notes 1 and 2)0.5	
Voltage range applied to any output in the power-off state, V _O (see Note 1)	
Input clamp current, I _{IK} (V _I < 0)	–20 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 3): D package	73°C/W
(see Note 3): DB package	82°C/W
(see Note 3): DGV package	120°C/W
(see Note 3): NS package	64°C/W
(see Note 3): PW package	108°C/W
(see Note 4): RGY package	39°C/W
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 5.5 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.
- 4. The package thermal impedance is calculated in accordance with JESD 51-5.

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recommended operating conditions (see Note 5)

			SN54L	V163A	SN74L	V163A	
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage		2	5.5	2	5.5	V
		V _{CC} = 2 V	1.5		1.5		
V	High level in put college	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		V
VIH	High-level input voltage	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		
		V _{CC} = 2 V		0.5		0.5	
V	Low lovel input valtage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		$V_{CC} \times 0.3$		$VCC \times 0.3$	V
V_{IL}	Low-level input voltage	$V_{CC} = 3 V \text{ to } 3.6 V$		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$.<	$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	
\vee_{I}	Input voltage		0,0	5.5	0	5.5	V
VO	Output voltage		0	Vcc	0	VCC	V
		V _{CC} = 2 V	Q.	-50		-50	μΑ
	High lovel output ourrent	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-2		-2	
ЮН	High-level output current	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		-6		-6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		-12		-12	
		V _{CC} = 2 V		50		50	μΑ
la.	Low-level output current	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2		2	
lOL	Low-level output current	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		6		6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		12		12	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		200		200	
Δt/Δν	Input transition rise or fall rate	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		100		100	ns/V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		20		20	
T_A	Operating free-air temperature		-55	125	-40	85	°C

NOTE 5: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		.,	SN5	4LV163A	l	SN74	LV163A	١	
PARAMETER	TEST CONDITIONS	v _{CC}	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
	I _{OH} = -50 μA	2 V to 5.5 V	V _{CC} -0.1			V _{CC} -0.1			
V	$I_{OH} = -2 \text{ mA}$	2.3 V	2			2			V
VOH	I _{OH} = -6 mA	3 V	2.48			2.48			V
	$I_{OH} = -12 \text{ mA}$	4.5 V	3.8	Š	4	3.8			
	I _{OL} = 50 μA	2 V to 5.5 V		,Si	0.1			0.1	
V	I _{OL} = 2 mA	2.3 V		Q.	0.4			0.4	V
VOL	I _{OL} = 6 mA	3 V		5	0.44			0.44	V
	I _{OL} = 12 mA	4.5 V	2%	5	0.55			0.55	
l _l	V _I = 5.5 V or GND	0 to 5.5 V	0		±1			±1	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V	Q.		20			20	μΑ
l _{off}	V_I or $V_O = 0$ to 5.5 V	0			5			5	μΑ
Ci	$V_I = V_{CC}$ or GND	3.3 V		1.8			1.8		pF



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timing requirements over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

			T _A = 2	25°C	SN54L	V163A	SN74L\	/163A	
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t _W	Pulse duration, CLK high or low		7		7		7		ns
		CLR	6		6	4	6		
١.	Output the share OLIVA	Data (A, B, C, and D)	7.5		8.5	75.41	8.5		
t _{su}	Setup time before CLK↑	ENP, ENT	9.5		্বা	7/1	11		ns
		LOAD low	10		11.5		11.5		
t _h	Hold time, all synchronous inputs after CLK↑		1.5		1.5		1.5		ns

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

			$T_A = 1$	25°C	SN54L	/163A	SN74L\	/163A	
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t _W	Pulse duration, CLK high or low		5		5		5		ns
	CLR	4		4	4	4			
١.	0	Data (A, B, C, and D)	5.5		6.5	15.11	6.5		
t _{su}	Setup time before CLK↑	ENP, ENT	7.5		9.	71.	9		ns
		LOAD low	8		9.5		9.5		
th	Hold time, all synchronous inputs after CLK↑	-	1		1		1		ns

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

			T _A = 1	25°C	SN54L	V163A	SN74L\	/163A	LINUT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t _W	Pulse duration, CLK high or low		5		5		5		ns
		CLR	3.5		3.5	4	3.5		
١.	0	Data (A, B, C, and D)	4.5		4.5	15.71	4.5		
t _{su}	Setup time before CLK↑	ENP, ENT	5		6	71.	6		ns
		LOAD low	5		6		6		
t _h	Hold time, all synchronous inputs after CLK↑		1		1		1		ns

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	LOAD	T	A = 25°C	;	SN54L	/163A	SN74L	/163A	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
,			C _L = 15 pF	50*	115*		40*		40		N 41 1-
f _{max}			$C_L = 50 pF$	30	90		25		25		MHz
		Q			8.5*	16.2*	1*	19.5*	1	19.5	
	CLK	RCO (count mode)	C 45 pF		9.1*	17*	1*	20.5*	1	20.5	20
^t pd		RCO (preset mode)	C _L = 15 pF		12.1*	20.6*	1*	24.5*	1	24.5	ns
	ENT	RCO			8.7*	15.7*	*	19*	1	19	
		Q			11	19.2	91	22.5	1	22.5	
[†] pd		RCO (count mode)	C: - 50 55		11.9	20	1	23.5	1	23.5	ns
		RCO (preset mode)	C _L = 50 pF		14.6	23.6	1	27.5	1	27.5	115
	ENT	RCO			11.7	18.7	1	22	1	22	2

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

	FROM	то	LOAD	T,	A = 25°C	;	SN54L\	/163A	SN74L	/163A		
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
£.			C _L = 15 pF	80*	160*		70*		70		MHz	
f _{max}			C _L = 50 pF	55	125		50		50		IVITZ	
		Q			6.2*	12.8*	1*	15*	1	15		
	CLK	RCO (count mode)	C: 45 pF	0 45 5		6.8*	13.6*	1*	16*	1	16	
^t pd	tpd RCO (preset mo	RCO (preset mode)	C _L = 15 pF		8.8*	17.2*	1* <	20*	1	20	ns	
	ENT	RCO			6.5*	12.3*	1 *)	14.5*	1	14.5		
		Q			8	16.3	91	18.5	1	18.5		
^t pd	CLK	RCO	C 50 pF		8.8	17.1	1	19.5	1	19.5	ns	
		RCO (preset mode)	C _L = 50 pF		10.7	20.7	1	23.5	1	23.5	115	
	ENT	RCO			8.2	15.8	1	18	1	18		

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.



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switching characteristics over recommended operating free-air temperature range, $V_{\hbox{CC}}$ = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	LOAD	T	_Δ = 25°C	;	SN54L\	/163A	SN74L\	/163A	LINUT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			C _L = 15 pF	135*	210*		115*		115		N 41 1-
f _{max}			$C_L = 50 pF$	95	160		85		85		MHz
		Q			4.7*	8.1*	1*	9.5*	1	9.5	
	CLK	RCO (count mode)	0 45 -5		5.2*	8.1*	1*	9.5*	1	9.5	
^t pd		RCO (preset mode)	C _L = 15 pF		6.4*	10.3*	1*	12*	1	12	ns
	ENT	RCO			4.9*	8.1*	Ą,	9.5*	1	9.5	
		Q			6.1	10.1	01	11.5	1	11.5	
	CLK	RCO (count mode)	C: 50 pF		6.6	10.1	1	11.5	1	11.5	
^t pd		RCO (preset mode)	C _L = 50 pF		7.8	12.3	1	14	1	14	ns
	ENT	RCO			6.3	10.1	1	11.5	1	11.5	

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, $V_{CC} = 3.3 \text{ V}$, $C_L = 50 \text{ pF}$, $T_A = 25^{\circ}\text{C}$ (see Note 6)

	DADAMETED	SN			
	PARAMETER	MIN	TYP	MAX	UNIT
VOL(P)	Quiet output, maximum dynamic VOL		0.3	0.8	V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.2	-0.8	V
V _{OH(V)}	Quiet output, minimum dynamic V _{OH}		3		V
VIH(D)	High-level dynamic input voltage	2.31			V
V _{IL(D)}	Low-level dynamic input voltage			0.99	V

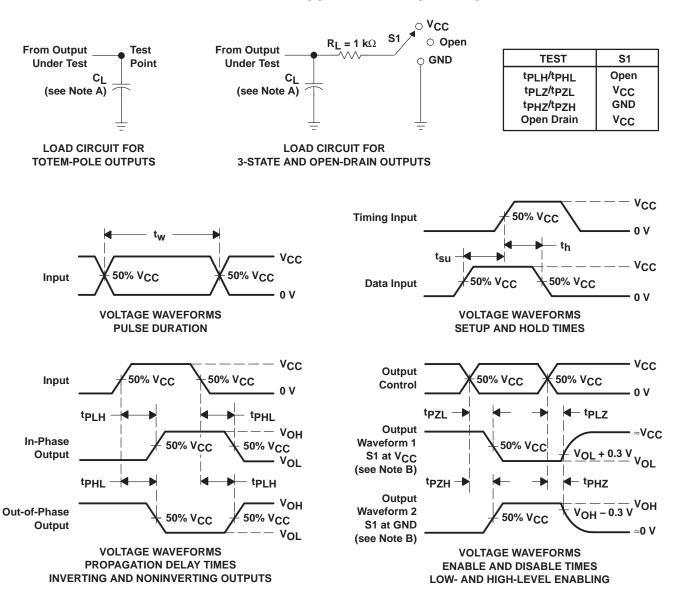
NOTE 6: Characteristics are for surface-mount packages only.

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER		TEST CONDITIONS		VCC	TYP	UNIT
Γ	<u> </u>	Down dissination conscitons	C. F0 pF	f = 10 MHz	3.3 V	23.8	pF
Cpd	Cpd	Power dissipation capacitance	$C_L = 50 pF$,		5 V	26	



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_{O} = 50 \Omega$, $t_{r} \leq 3$ ns. $t_{f} \leq 3$ ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpHL and tpLH are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

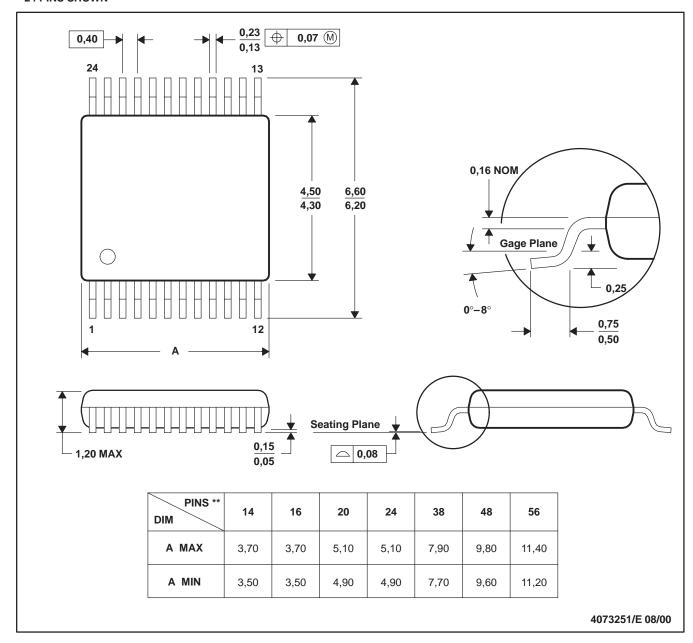
Figure 1. Load Circuit and Voltage Waveforms



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



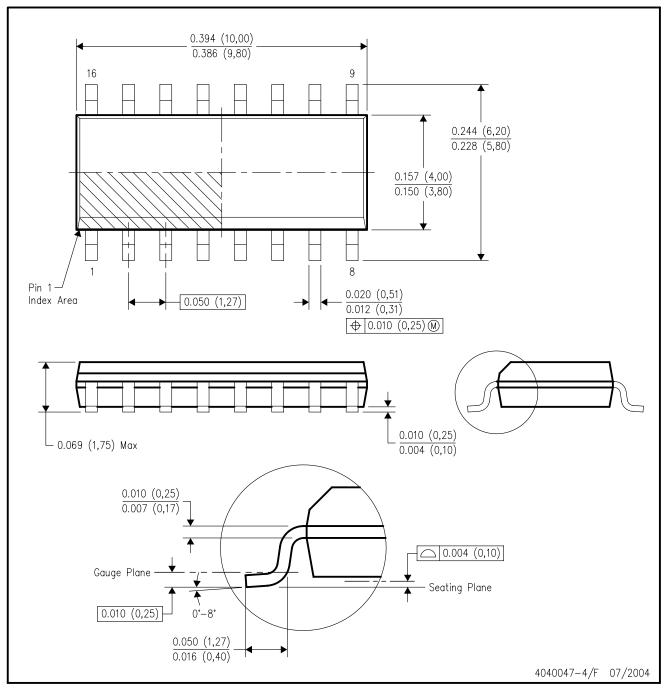
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153 14/16/20/56 Pins – MO-194



D (R-PDSO-G16)

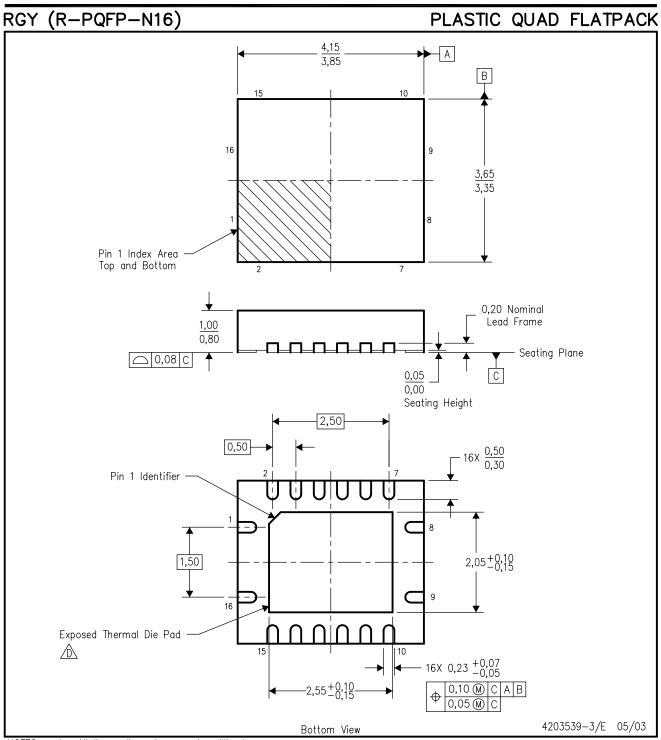
PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.





- NOTES: A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-Lead) package configuration.
 - The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane.

 This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
 - E. Package complies to JEDEC MO-241 variation BB.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

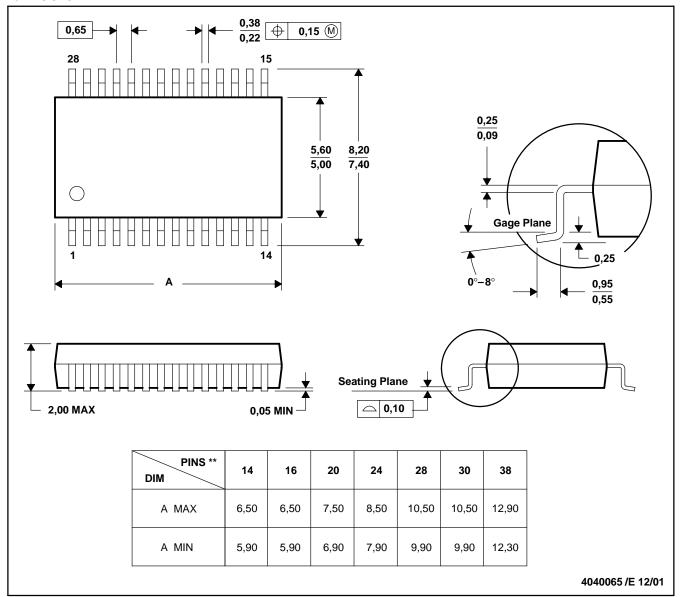
- . All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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